

NOT RECOMMENDED FOR NEW DESIGN USE DMP3036SSS



DMP3035LSS

SINGLE P-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

BV _{DSS}	R _{DS(ON)} Max	I _D Max T _A = +25°C
-30V	$14m\Omega$ @ $V_{GS} = -20V$	-10A
	$18m\Omega$ @ $V_{GS} = -10V$	-8.8A
	$36m\Omega$ @ $V_{GS} = -4.5V$	-6.2A

Features and Benefits

- Low On-Resistance
- Low Gate Threshold Voltage
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

Description

This MOSFET is designed to minimize the on-state resistance (R_{DS(ON)}), yet maintain superior switching performance, making it ideal for high efficiency power management applications.

Applications

- Backlighting
- Power Management Functions
- DC-DC Converters

Mechanical Data

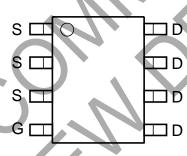
- Case: SO-8
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals Connections: See Diagram
- Terminals: Finish Matte Tin Annealed over Copper Leadframe.

 Solderable per MIL-STD-202, Method 208 @3
 - Weight: 0.074 grams (Approximate)

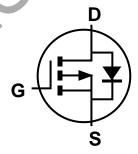
SO-8







Top View Internal Schematic



Equivalent Circuit

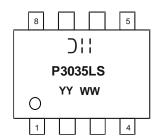
Ordering Information (Note 4)

Part Number	Case	Packaging
DMP3035LSS-13	SO-8	2,500/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



);; = Manufacturer's Marking
P3035LS = Product Type Marking Code
YYWW = Date Code Marking
YY or YY = Year (ex: 17 = 2017)
WW = Week (01 to 53)



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DMP3035LSS

Maximum Ratings (@ $T_A = +25^{\circ}C$, unless otherwise specified.)

Characteris		Symbol	Value	Unit	
Drain-Source Voltage			V _{DSS}	-30	V
Gate-Source Voltage			V _{GSS}	±25	V
Drain Current (Note 5) ($V_{GS} = -20V$) Steady State $T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$		I _D	-10 -8	А	
Pulsed Drain Current (Note 6)		I _{DM}	-80	Α	

Thermal Characteristics

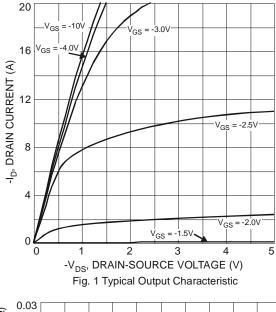
Characteristic	Symbol	Value	Unit
Total Power Dissipation (Note 5)	P _D	2.0	W
Thermal Resistance, Junction to Ambient	R _{θJA}	60	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C

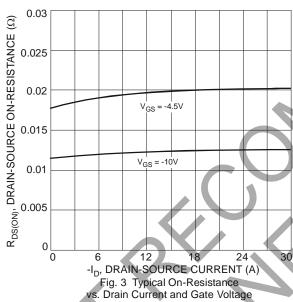
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)						
Drain-Source Breakdown Voltage	BV _{DSS}	-30	1		V	$V_{GS} = 0V, I_D = -250\mu A$
Zero Gate Voltage Drain Current	I _{DSS}	17		-1	μA	$V_{DS} = -30V, V_{GS} = 0V$
Gate-Source Leakage	lgss	1	_	±100 ±800	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$ $V_{GS} = \pm 25V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 7)						
Gate Threshold Voltage	V _{GS(TH)}	-1	<u> </u>	-2	V	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$
Static Drain-Source On-Resistance	R _{DS(ON)}	1	11 15 27	14 18 36	mΩ	$V_{GS} = -20V, I_D = -11A$ $V_{GS} = -10V, I_D = -8A$ $V_{GS} = -4.5V, I_D = -5A$
Forward Transconductance	Gfs	_	12	_	S	V _{DS} = -10V, I _D = -12A
Diode Forward Voltage (Note 7)	V _{SD}	-0.5	_	-1.1	V	V _{GS} = 0V, I _S = -2A
DYNAMIC CHARACTERISTICS						
Input Capacitance	C _{iss}		1,655	_	pF	
Output Capacitance	C _{oss}		286	_	pF	$V_{DS} = -20V, V_{GS} = 0V$ f = 1.0MHz
Reverse Transfer Capacitance	C _{rss}	_	240	_	pF	1 - 1.500112
Gate Resistance	R _G		2.3	_	Ω	$V_{GS} = 0V$, $V_{DS} = 0V$, $f = 1MHz$
SWITCHING CHARACTERISTICS						
Total Gate Charge	Q_{g}	_	15.3 30.7	_	$V_{DS} = -15V$, $V_{GS} = -4.5V$, $I_{D} = -4.5V$, $I_{DS} = -15V$, $V_{GS} = -10V$, $I_{DS} = -15V$, $V_{GS} = -10V$, $V_{DS} = -15V$, $V_{CS} = -10V$	
Gate-Source Charge	Q _{gs}	_	3.5	_	nC	V _{DS} = -15V, V _{GS} = -10V, I _D = -8A
Gate-Drain Charge	Q _{gd}	_	7.9	_		V _{DS} = -15V, V _{GS} = -10V, I _D = -8A
Turn-On Delay Time	t _{D(ON)}	_	5.1	_		
Rise Time	t _R	_	8	_		$V_{GS} = -10V, V_{DS} = -15V,$
Turn-Off Delay Time	t _{D(OFF)}	_	46	_	ns	$R_D = 15\Omega$, $R_G = 6\Omega$
Fall Time	t _F	_	30			

5. Device mounted on 1 inch² FR-4 board with 2 oz. copper, in a still-air environment with $T_A = +25$ °C. Notes:

Repetitive rating, pulse width limited by junction temperature.
 Short duration pulse test used to minimize self-heating effect.





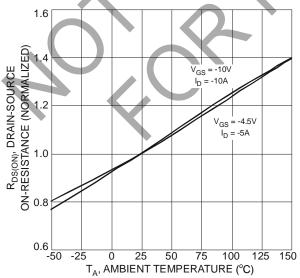
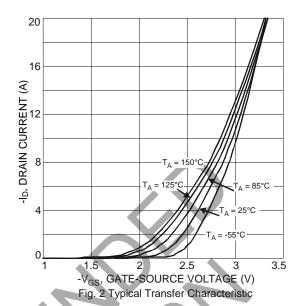
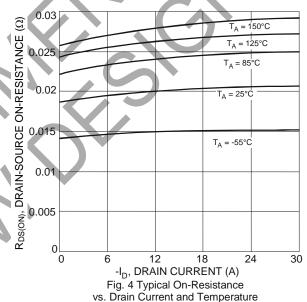
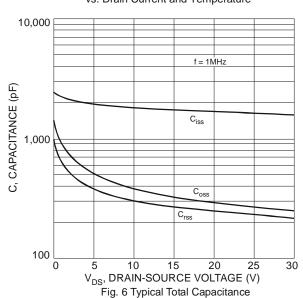


Fig. 5 Normalized On-Resistance vs. Ambient Temperature









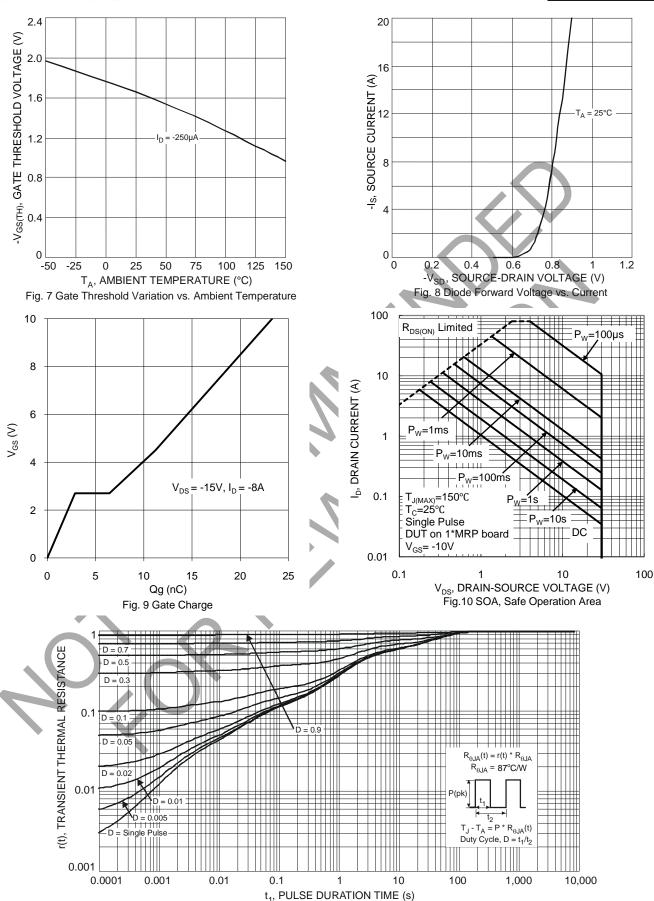


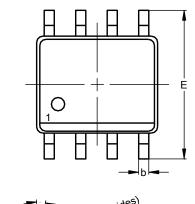
Fig. 11 Transient Thermal Response

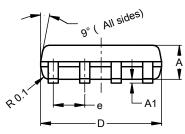


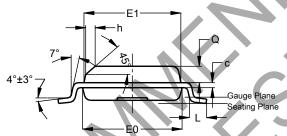
Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

SO-8



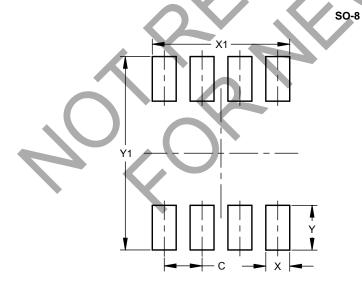




SO-8					
Dim	Min	Max	Тур		
Α	1.40	1.50	1.45		
A1	0.10	0.20	0.15		
q	0.30	0.50	0.40		
C	0.15	0.25	0.20		
D	4.85	4.95	4.90		
Е	5.90	6.10	6.00		
E1	3.80	3.90	3.85		
E0	3.85	3.95	3.90		
е	-		1.27		
h			0.35		
_	0.62	0.82	0.72		
Ø	0.60	0.70	0.65		
All Dimensions in mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



Dimensions	Value (in mm)
С	1.27
Х	0.802
X1	4.612
Υ	1.505
Y1	6.50



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